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March 2015



## FGH40N60SF 600 V, 40 A Field Stop IGBT

## Features

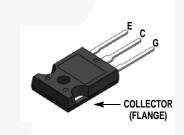
- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 2.3 V @ I<sub>C</sub> = 40 A
- High Input Impedance
- Fast Switching:  $E_{OFF} = 8 \text{ uJ/A}$
- RoHS Compliant

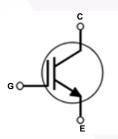
## Applications

• Solar Inverter, UPS, Welder, PFC

## **General Description**

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





## **Absolute Maximum Ratings**

Symbol	Description	Ratings	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage		600	V
V	Gate to Emitter Voltage		±20	V
V <sub>GES</sub>	Transient Gate-to-Emitter Voltage	±30	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	80	A
	Collector Current $@ T_C = 100^{\circ}C$		40	A
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	120	А
P <sub>D</sub>	Maximum Power Dissipation $@T_{C} = 25^{\circ}C$		290	W
	Maximum Power Dissipation $@T_{C} = 100^{\circ}C$		116	W
Т <sub>Ј</sub>	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

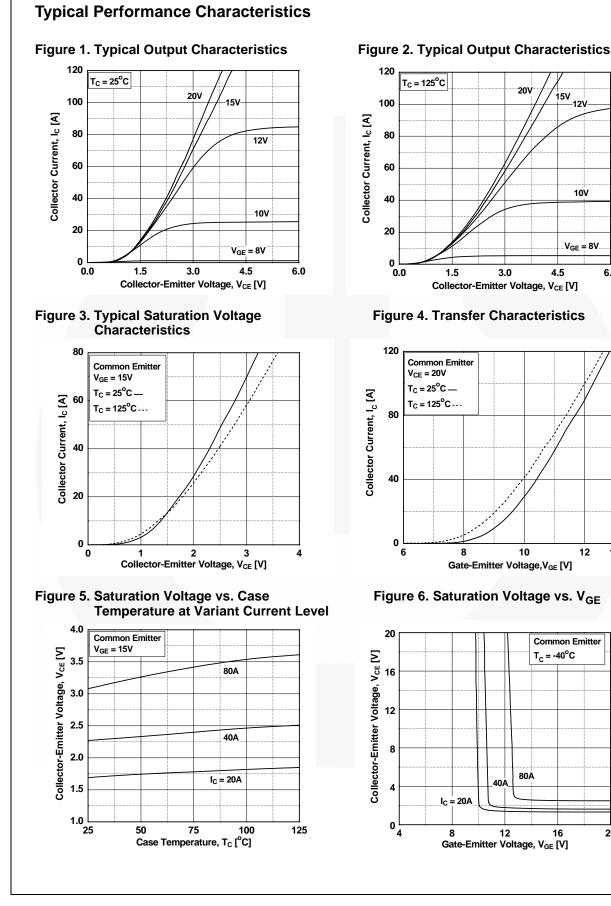
### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

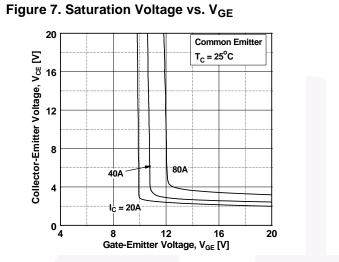
Part Number		Top Mark	Package	Packing Method	Reel Size	Tape Width	Qu	Quantity	
FGH40N60	40N60SFTU FGH40N60SF TO-247		Tube	N/A	N/A		30		
Electric	al Ch	aracteristic	s of the l	<b>GBT</b> $T_{C} = 25^{\circ}C$ unless other	rwise noted				
Symbol	Parameter			Test Conditio	ns Mir	n. Typ.	Max.	Unit	
Off Charge	toriction				·				
BV <sub>CES</sub>	teristics Collector to Emitter Breakdown Voltage		V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA	600		_	V		
ΔBV <sub>CES</sub> /			-		000			v	
$\Delta D_{VCES}^{\prime}$	Voltage	nperature Coefficient of Breakdown tage		$V_{GE}$ = 0 V, $I_C$ = 250 $\mu$ A	-	0.6	-	V/ºC	
I <sub>CES</sub>	Collect	ector Cut-Off Current		$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA	
I <sub>GES</sub>	G-E Le	akage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA	
On Charac	1						6.5		
V <sub>GE(th)</sub>	G-E Th	reshold Voltage		$I_{C} = 250 \ \mu A, \ V_{CE} = V_{GE}$	4.0		6.5	V	
V <sub>CE(sat)</sub>	Collect	Collector to Emitter Saturation Voltage		$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V}$ $I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$	-	2.3	2.9	V	
CE(Sat)				$T_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$	-	2.5	-	V	
				-					
Dynamic C	haracte	ristics							
C <sub>ies</sub>	Input C	apacitance			-	2110	-	pF	
C <sub>oes</sub>	Output	ut Capacitance rse Transfer Capacitance		V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>GE</sub> = 0 V, f = 1 MHz	-	200	-	pF	
C <sub>res</sub>	Revers				-	60	-	pF	
Switching	Charact	eristics							
t <sub>d(on)</sub>	1	Furn-On Delay Time Rise Time Furn-Off Delay Time Fall Time			-	25	-	ns	
t <sub>r</sub>	Rise Ti			-	-	42	-	ns	
t <sub>d(off)</sub>	Turn-O			V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,	-	115	-	ns	
t <sub>f</sub>	Fall Tin			$R_{G} = 10 \Omega$ , $V_{GE} = 15 V$ ,	-	27	54	ns	
Eon	Turn-O	n Switching Loss		Inductive Load, T <sub>C</sub> = 25°C	°C -	1.13	-	mJ	
E <sub>off</sub>	Turn-O	ff Switching Loss			-	0.31	-	mJ	
E <sub>ts</sub>	Total S	witching Loss			-	1.44	-	mJ	
t <sub>d(on)</sub>	Turn-O	n Delay Time			-	24	-	ns	
t <sub>r</sub>	Rise Ti	me		1	-	43	-	ns	
t <sub>d(off)</sub>	Turn-O	ff Delay Time		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,	-	120	-	ns	
t <sub>f</sub>	Fall Tin	all Time		$R_{G} = 10 \Omega$ , $V_{GE} = 15 V$ ,		30	-	ns	
E <sub>on</sub>	Turn-O	n Switching Loss		Inductive Load, T <sub>C</sub> = 12	5°C -	1.14	-	mJ	
E <sub>off</sub>	Turn-O	Turn-Off Switching Loss			-	0.48	- (	mJ	
E <sub>ts</sub>	Total S	witching Loss			-	1.62	-	mJ	
Qg	Total G	ate Charge			-	120	-	nC	
Q <sub>ge</sub>	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	14	-	nC	
Q <sub>gc</sub>	Gate to	Gate to Collector Charge		V <sub>GE</sub> = 15 V	-	58	_	nC	

6.0

13



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**Typical Performance Characteristics** 

Figure 9. Capacitance Characteristics

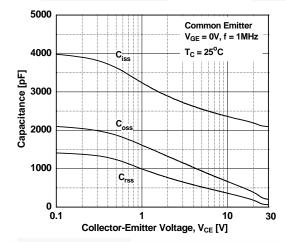


Figure 11. SOA Characteristics

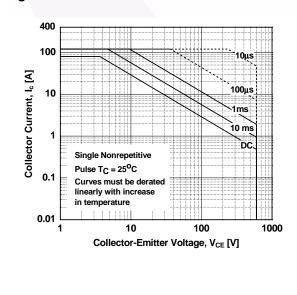


Figure 8. Saturation Voltage vs. V<sub>GE</sub>

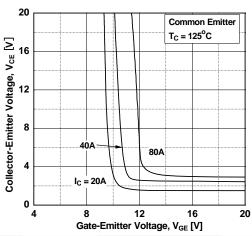


Figure 10. Gate charge Characteristics

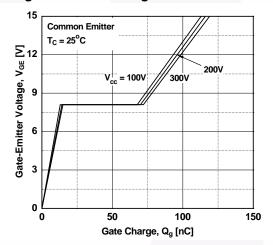
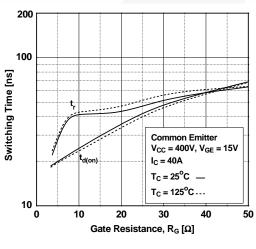
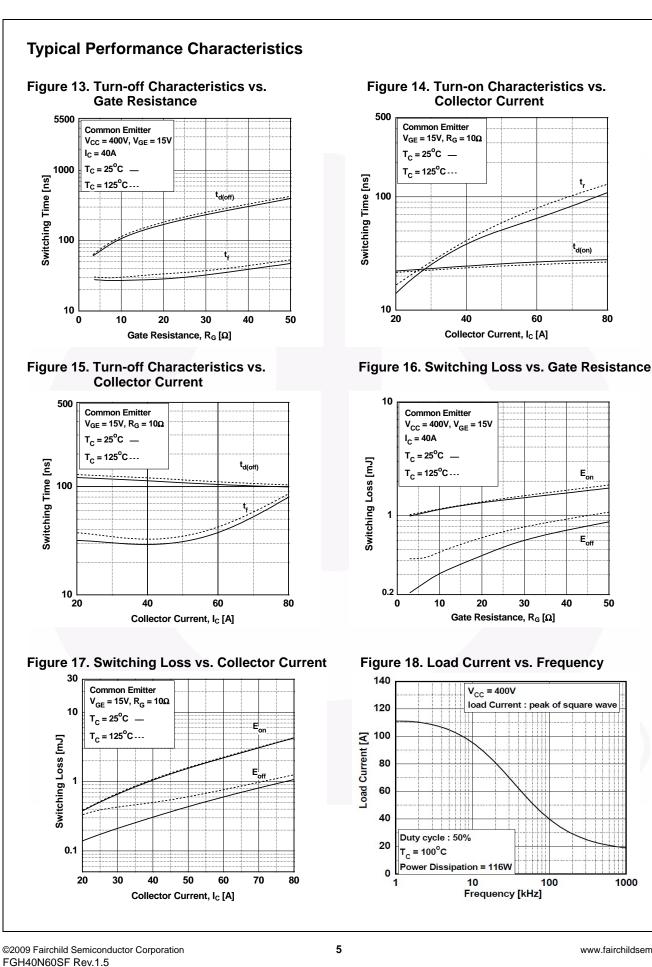


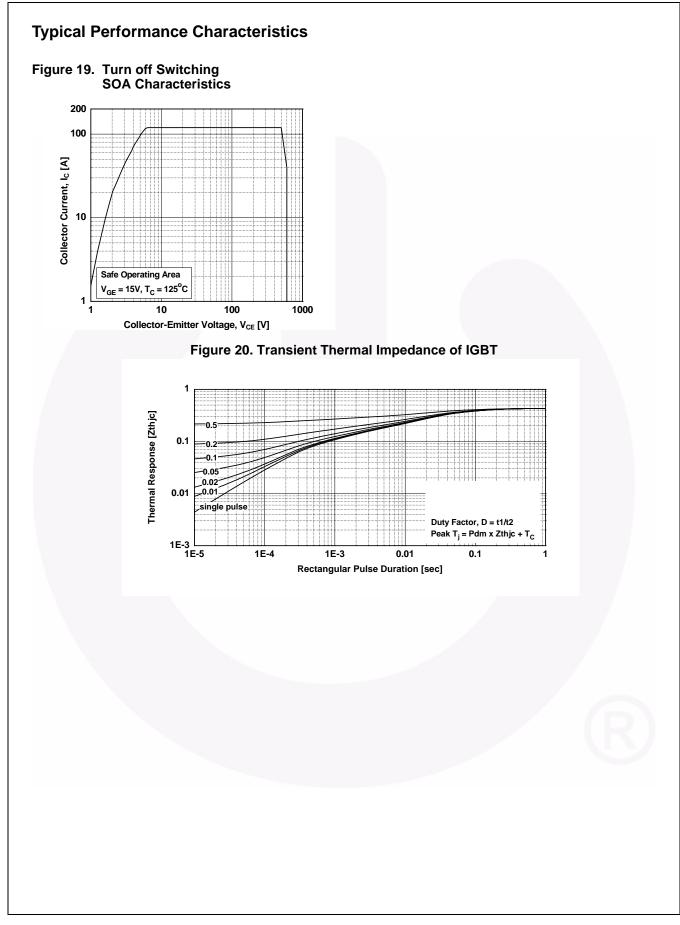
Figure 12. Turn-on Characteristics vs. Gate Resistance

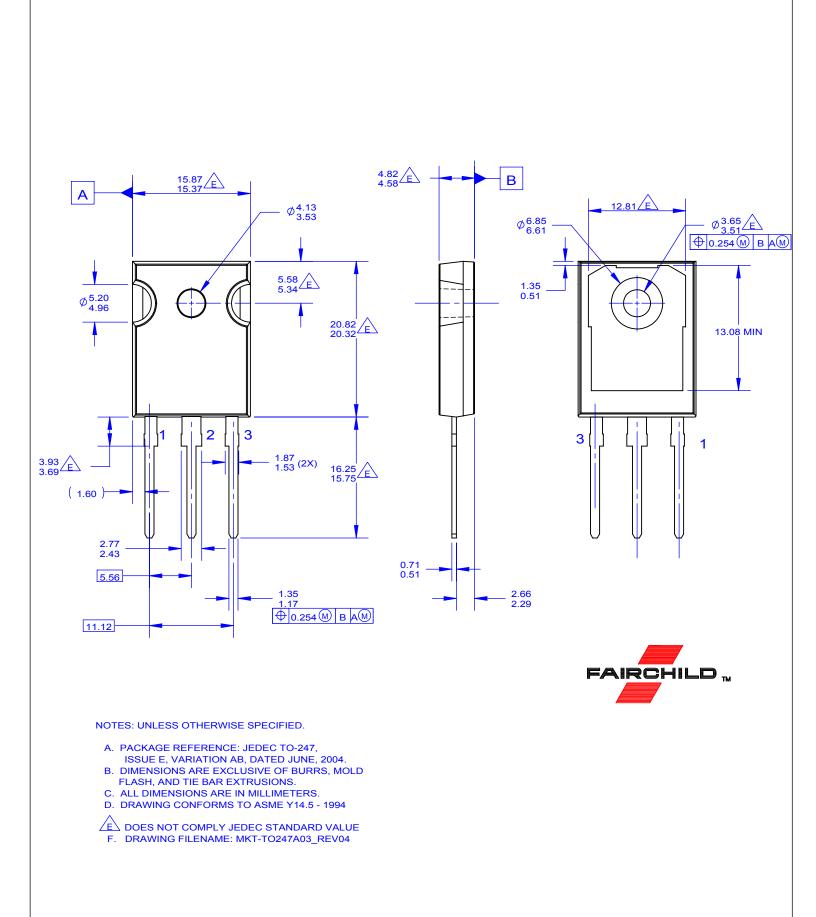


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Rev. 177